

Nch 600V 25A Power MOSFET

Datasheet

V _{DSS}	600V
R _{DS(on)} (Max.)	0.15Ω
Ι _D	±25A
P _D	150W

Features

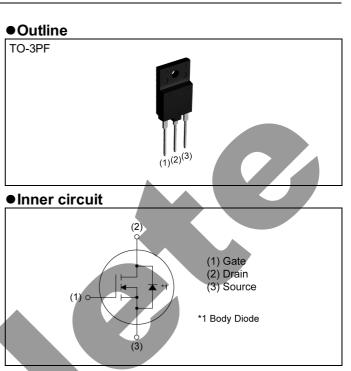
- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage (V_{GSS}) guaranteed to be ±30V.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.
- 6) Pb-free lead plating ; RoHS compliant

Application

Switching Power Supply

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	600	V
Continuous drain current	T _C = 25°C	I _D *1	±25	Α
	T _C = 100°C	Ι _D ^{*1}	±12.5	Α
Pulsed drain current		I _{D,pulse} *2	±100	А
Gate - Source voltage		V _{GSS}	±30	V
Avalanche energy, single pulse		E _{AS} *3	39	mJ
Avalanche energy, repetitive		E _{AR} *4	9.7	mJ
Avalanche current		I _{AR} *3	12.5	А
Power dissipation $(T_c = 25^{\circ}C)$		P _D	150	W
Junction temperature		Tj	150	°C
Range of storage temperature		T _{stg}	-55 to +150	°C
Reverse diode dv/dt		dv/dt	15	V/ns



Packaging specifications

	Packing	Tube
	Reel size (mm)	-
T	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	360
	Taping code	C8
	Marking	R6025ANZ

•Absolute maximum ratings

Parameter	Symbol	ymbol Conditions		Unit
Drain - Source voltage slope	dv/dt	V _{DS} = 480V, I _D = 25A T _j = 125°C	50	V/ns

•Thermal resistance

Parameter	Symbol	Values			Unit
	Symbol	Min.	Тур.	Max.	Orme
Thermal resistance, junction - case	R _{thJC}	-		0.83	°C/W
Thermal resistance, junction - ambient	R _{thJA}			40	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}		-	265	°C
●Electrical characteristics (T _a = 25°C)					

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Deremeter	C) mah al	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, 1 _D = 1mA	600	-	-	V
Drain - Source avalanche breakdown voltage	V _{(BR)DS}	V _{GS} = 0V, I _D = 12.5A	-	700	-	V
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.1	100 1000	μA
Gate - Source leakage current	I _{GSS}	V_{GS} = ±30V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	2.5	-	4.5	V
Static drain - source on - state resistance	R _{DS(on)} *6	$V_{GS} = 10V, I_D = 12.5A$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.12 0.24	0.15 -	Ω
Gate input resistance	R _G	f = 1MHz, open drain	-	2.2	-	Ω

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•Electrical characteristics (T_a = 25°C)

Deremeter	Sumbol	Conditions	Values			Linit
Parameter	Symbol			Тур.	Max.	Unit
Transconductance	${\sf g}_{\sf fs}{}^{*6}$	V _{DS} = 10V, I _D = 12.5A	14	20	-	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	3250	-	
Output capacitance	C _{oss}	V _{DS} = 10V	-	2400	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz		85		
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V,		33.4	-	
Effective output capacitance, time related	C _{o(tr)}	$V_{\rm DS} = 0V$ to 480V	-	96.5	-	pF
Turn - on delay time	t _{d(on)} *6	$V_{DD} \simeq 300$ V, V_{GS} = 10V	-	50	-	
Rise time	t _r *6	I _D = 12.5A		135	-	10.0
Turn - off delay time	t _{d(off)} *6	R _L = 24Ω		185	370	ns
Fall time	t _f *6	R _G = 10Ω		110	220	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Symbol Conditions		Values			l lait
Parameter			Min.	Тур.	Max.	Unit
Total gate charge	Q _g *6	V _{DD} ≃ 300V	-	88	-	
Gate - Source charge	Q _{gs} *6	I _D = 25A	-	25	-	nC
Gate - Drain charge	Q _{gd} *6	V _{GS} = 10V	-	30	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300V$, $I_D = 25A$	-	5.9	-	V

- *1 Limited only by maximum temperature allowed.
- *2 Pw \leq 10µs, Duty cycle \leq 1%
- *3 L \simeq 500µH, V_DD = 50V, R_G = 25Ω, starting T_j = 25°C
- *4 L \simeq 500µH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25°C, f = 10kHz
- *5 Reference measurement circuits Fig.5-1.

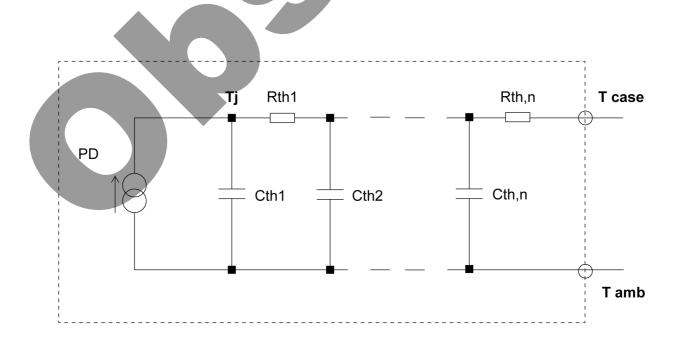
*6 Pulsed

•Body diode electirical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Currence of	Canditiana	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Inverse diode continuous, forward current	۱ _S *1	T - 25°0	-	-	25	A
Inverse diode direct current, pulsed	^{*2}	T _C = 25°C	-	-	100	A
Forward voltage	V_{SD}^{*6}	V _{GS} = 0V, I _S = 12.5A	-	-	1.5	V
Reverse recovery time	t _{rr} *6		-	677	-	ns
Reverse recovery charge	Q _{rr} *6	I _S = 25A di/dt = 100A/µs	-	15.3	-	μC
Peak reverse recovery current	۴ ⁶ ا		-	45.1		А
Peak rate of fall of reverse recovery current	di _{rr} /dt	T _j = 25°C		850	_	A/µs

•Typical transient thermal characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.0564		C _{th1}	0.0077	
R _{th2}	0.391	K/W	C _{th2}	0.0779	Ws/K
R _{th3}	1.26		C _{th3}	1.13	





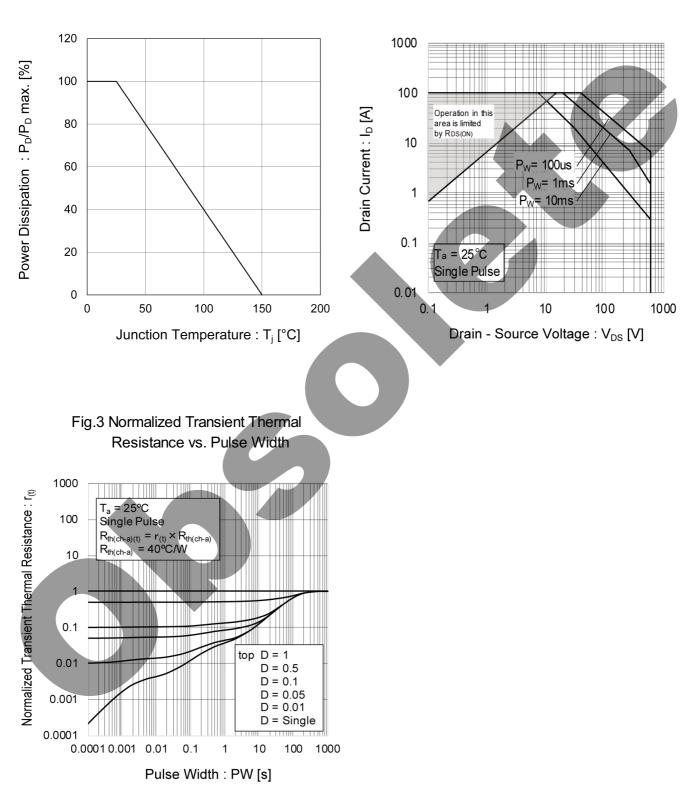


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



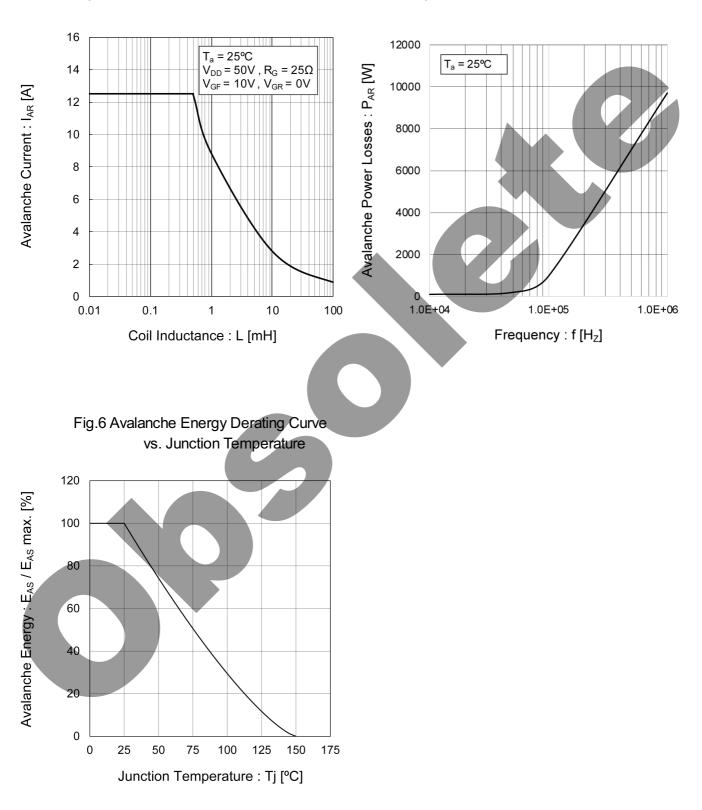


Fig.4 Avalanche Current vs. Inductive Load

Fig.5 Avalanche Power Losses



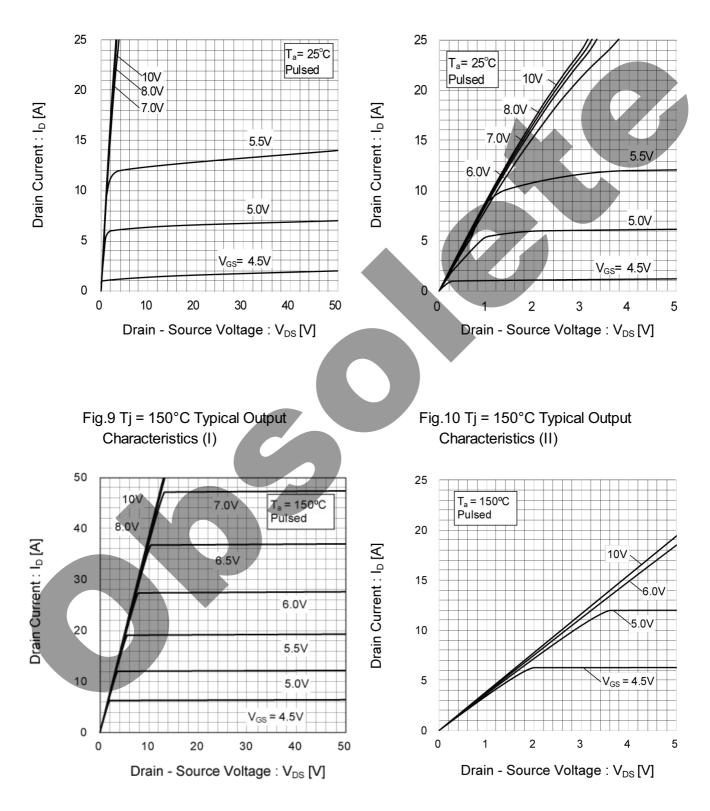


Fig.7 Typical Output Characteristics(I)

Fig.8 Typical Output Characteristics(II)



Fig.12 Typical Transfer Characteristics

• Electrical characteristic curves

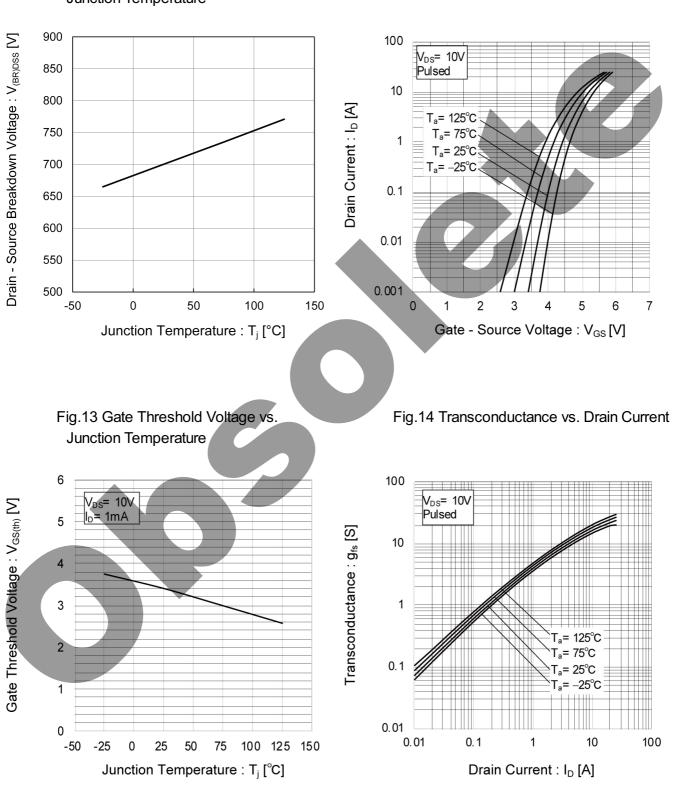
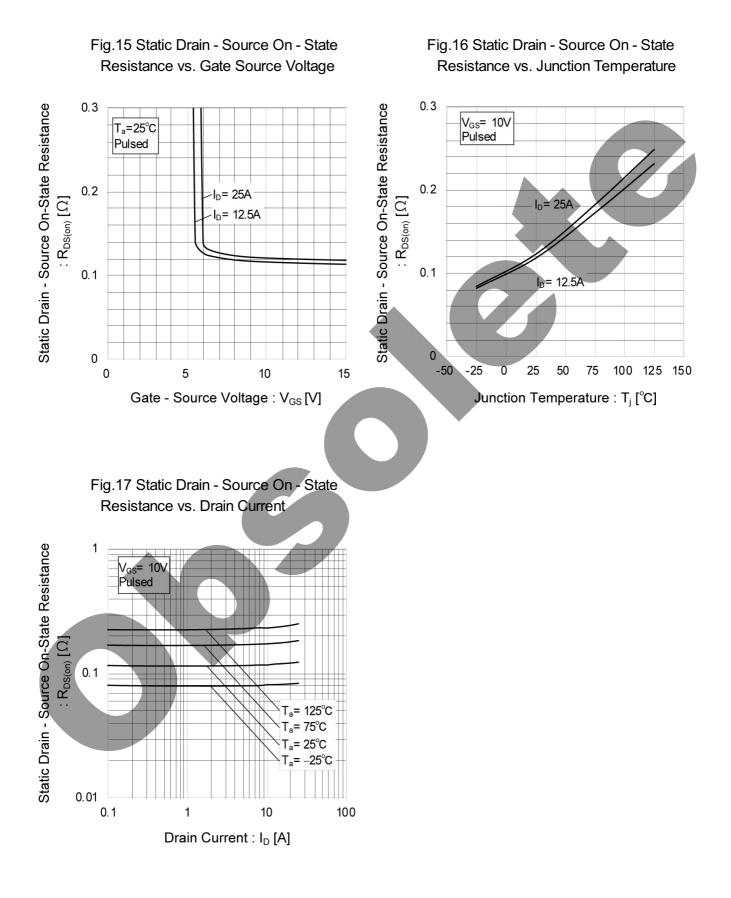


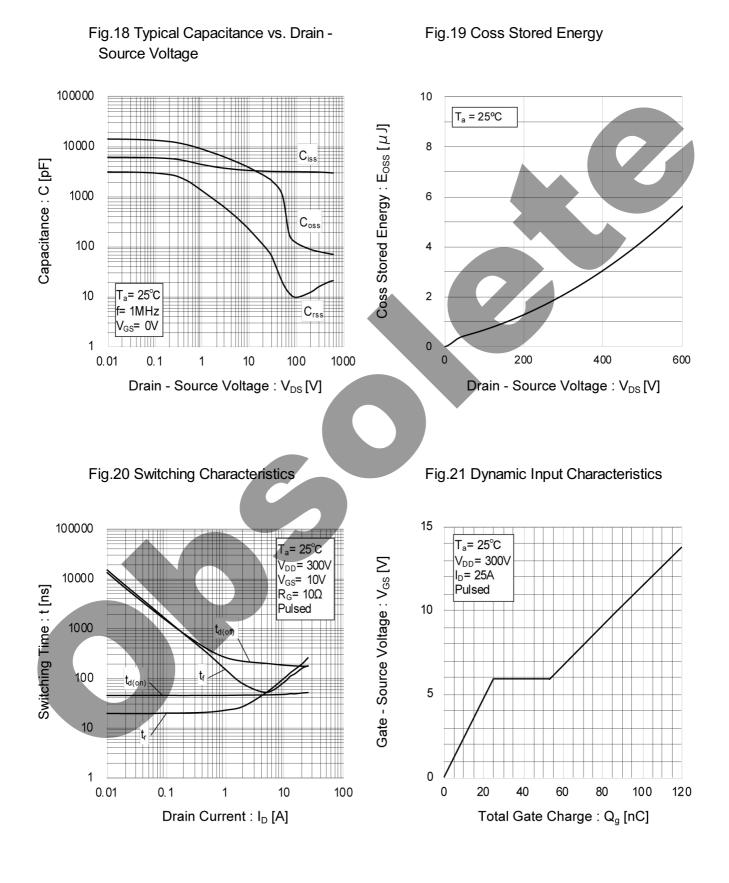
Fig.11 Breakdown Voltage vs. Junction Temperature



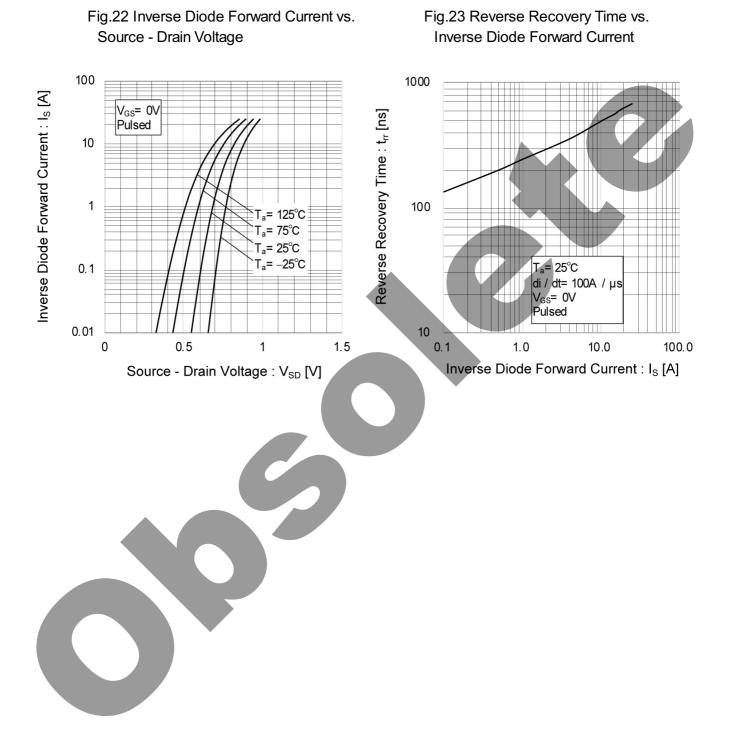








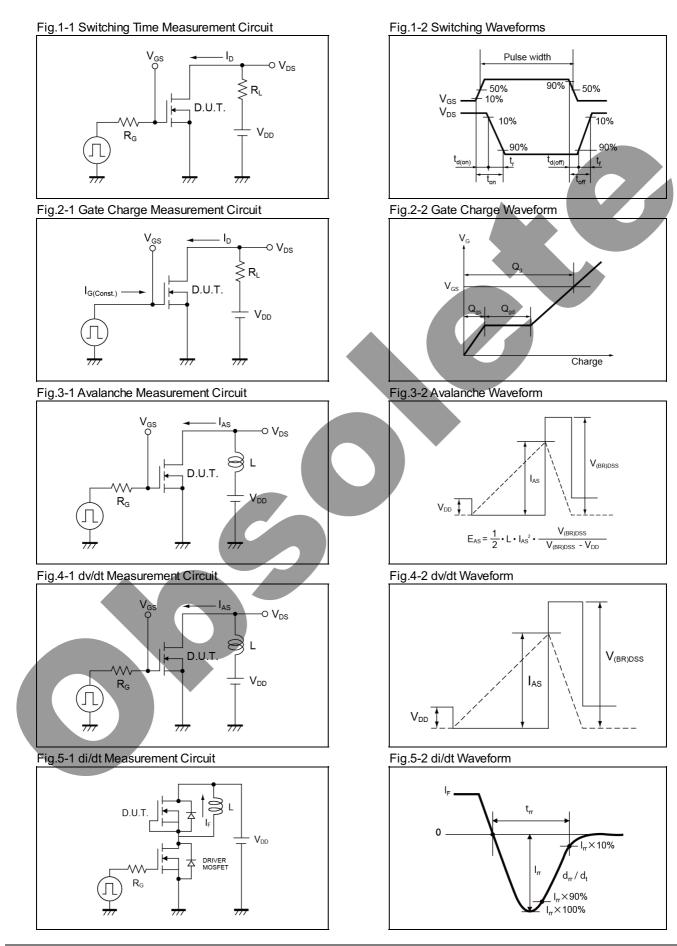








Measurement circuits

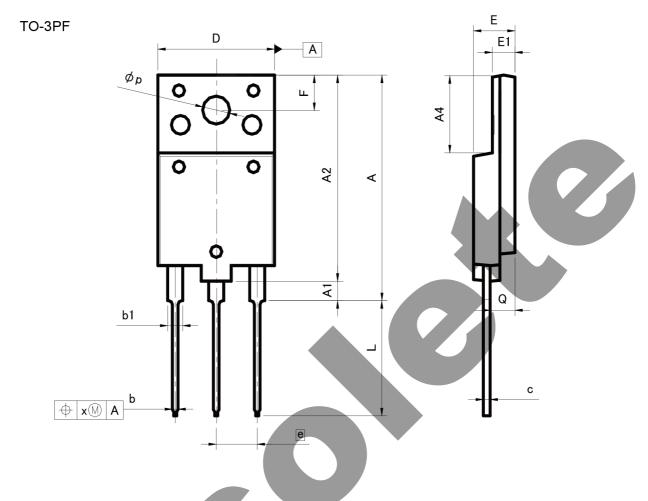


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Dimensions



DIM	MILIM	ETERS	INC	HES
DIN	MIN	MAX	MIN	MAX
A	26.30	26.70	1.035	1.051
A1	2.30	2.70	0.091	0.106
A2	26.30	26.70	1.035	1.051
A4	9.80	10.20	0.386	0.402
b	0.65	0.95	0.026	0.037
b1	1.80	2.20	0.071	0.087
с	0.80	1.10	0.031	0.043
D	15.30	15.70	0.602	0.618
Ш	5.30	5.70	0.209	0.224
e	5.4	45	0.215	-
E1	2.80	3.20	0.110	0.126
F	4.30	4.70	0.169	0.185
L	14.60	15.00	0.575	0.591
р	3.40	3.80	0.134	0.150
Q	3.10	3.50	0.122	0.138
х	_	0.50	_	0.020

Dimension in mm/inches



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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ		CLASSⅢ	

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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